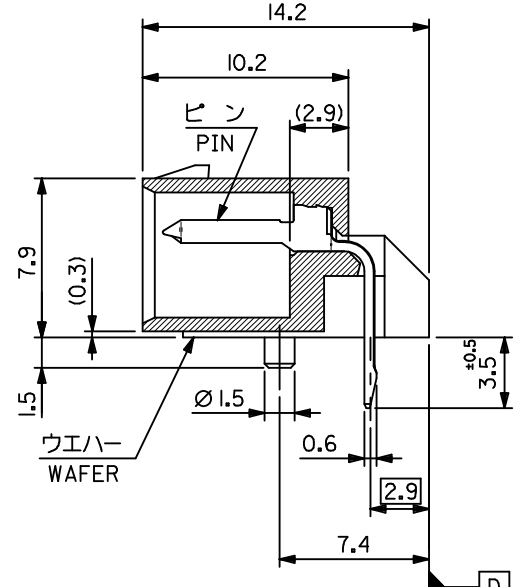
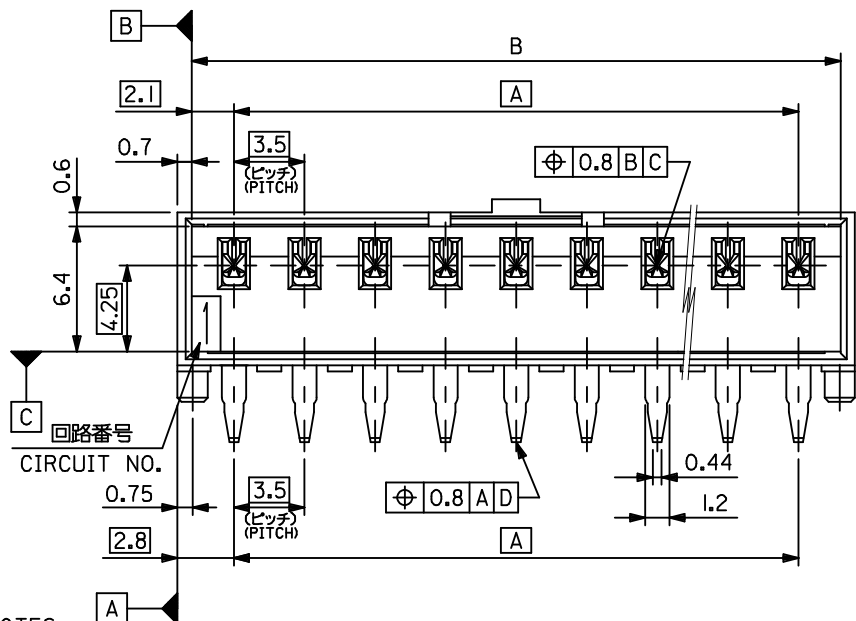


基板取付穴推奨寸法 (参考) (t=1.6)
RECOMMENDED P.C. BOARD HOLE DIM. (REF.)



8.7	54.6	53.2	49.0	53259-1520	15
				-1510	
				-1420	14
				-1410	
				-1320	13
				-1310	
				-1220	12
				-1210	
				-1120	11
				-1110	
				-1020	10
				-1010	
				-0920	9
				-0910	
				-0820	8
				-0810	
				-0720	7
				-0710	
				-0620	6
				-0610	
				-0520	5
				-0510	
				-0420	4
				-0410	
				-0320	3
				-0310	
				-0220	2
				53259-0210	
(D)	C	B	A	ENG. NO.	CKT. 種別

注記 NOTES

1. 嵌合相手 : 51067 シリーズ
MATE WITH : 51067 SERIES
2. 材質 MATERIAL
ウエハー : PBTP (ガラス15%入り)、UL94V-0
WAFER : PBTP (G.F 15%), UL94V-0
ピン : 53259-***10 [リン青銅、半田メッキ (t=0.254)]
PIN : [PHOS. BRO., SOLDER PLATED (t=0.254)]
53259-***20 [黄銅、半田メッキ (t=0.254)]
[BRASS, SOLDER PLATED (t=0.254)]

REVISED EC NO: J2014-1003 DRWN:TYAJIMA01 2013/12/25 CHKD:KASAKAWA 2013/12/25 APPR:NUKITA 2014/01/07 G	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY TYAJIMA01	DATE 2013/12/25	TITLE 3.5 W/B CONN WAFER ASSY R/A				
		10 OVER 30 UNDER	±0.25	CHECKED BY KASAKAWA	DATE 2013/12/25					
		30 OVER	±0.3	APPROVED BY NUKITA	DATE 2014/01/07					
ANGULAR ±3 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE CHART		DOCUMENT NO. SD-53259-006		SHEET NO. 1 OF 1		
SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION										